IN THE CLAIMS:

Please amend the claims as follows:

1. (Currently Amended): A method of fabricating liquid crystal display (LCD) panels, comprising:

forming a plurality of upper LCD panel sections having at least two different sizes on a first mother substrate and a plurality of lower LCD panel sections having at least two different sizes on a second mother substrate;

forming sealant patterns on at least one of the mother substrates;

attaching the first and second mother substrates to each other to bond the upper LCD panel sections with associated ones of the lower LCD panel sections to form at least first and second LCD panel units;

forming at least first cutting lines on each of the first and second mother substrates, the first cutting lines corresponding to a boundary of the first LCD panel unit, wherein the first cutting lines extend over at least one sealant pattern;

forming at least second cutting lines on each of the first and second mother substrates, the second cutting lines corresponding to a boundary of the second LCD panel unit; and

separating the first and second LCD panel units into individual LCD panels, wherein the first LCD panel unit is larger than the second LCD panel unit,

wherein each of the first and second mother substrates includes a plurality of dummy sections, each dummy section including a main dummy portion and a secondary dummy portion,

and at least one of the sealant patterns under the first cutting lines binds the main dummy portions and secondary dummy portions together during the separating step.

2. (Canceled).

3. (Previously Presented): The method according to claim 1, wherein the secondary dummy portions have a width of less than about 3 mm.

4. (Previously Presented): The method according to claim 1, wherein the sealant patterns are formed on non-display regions of the LCD panels.

5. (Previously Presented): The method according to claim 1, wherein the sealant patterns are positioned on both the main dummy portions and the secondary dummy portions.

6. (Previously Presented): The method according to claim 1, wherein sizes of the upper LCD panel sections on the first mother substrate and the lower LCD panel sections on the second mother substrate facing correspondingly at each other are substantially the same.

7. (Previously Presented): The method according to claim 1, wherein the lower LCD panel sections have a plurality of thin film transistors and a plurality of pixel electrodes, and the upper LCD panel sections have a plurality of color filters and a common electrode.

8. (Currently Amended): A method of fabricating liquid crystal display (LCD) panels, comprising:

forming a plurality of upper LCD panel sections having at least two different sizes on a first mother substrate and a plurality of lower LCD panel sections having at least two different sizes on a second mother substrate;

forming sealant patterns on at least one of the mother substrates;

attaching the first and second mother substrates to each other to bond the upper ~~liquid~~ LCD panel sections with associated ones of the lower LCD panel sections to form at least first and second LCD panel units;

forming at least first and second cutting lines on each of the first and second mother substrates; and

separating the first and second LCD panel units into individual LCD panels having different sizes,

wherein remnants of the separated mother substrates include main dummy portions and secondary dummy portions divided by the first cutting lines therebetween, and at least one of the sealant patterns is located underneath the first cutting lines such that at least one of the sealant

patterns under the first cutting lines bind the main dummy portions and secondary dummy portions together during the separating step.

9. (Previously Presented): The method according to claim 8, further comprising injecting liquid crystals into the separated LCD panels.

10. (Previously Presented): The method according to claim 8, wherein the secondary dummy portions have a width of less than about 3 mm.

11. (Previously Presented): The method according to claim 8, wherein sizes of the upper LCD panel sections on the first mother substrate and the lower LCD panel sections on the second mother substrate facing correspondingly at each other are substantially the same.

12. (Previously Presented): The method according to claim 8, wherein the lower LCD panel sections have a plurality of thin film transistors and a plurality of pixel electrodes, and the upper LCD panel sections have a plurality of color filters and a common electrode.

13. (Previously Presented): The method according to claim 1, further comprising injecting liquid crystals into the separated LCD panels.

14. (Canceled).

15. (Canceled).

16. (Previously Presented): A method of fabricating liquid crystal display (LCD) panels, comprising:

forming a plurality of upper LCD panel sections on a first substrate and a plurality of lower LCD panel sections on a second substrate;

forming sealant patterns extending in a first direction on at least one of the substrates;

attaching the first and second substrates to each other to bond the upper LCD panel sections with associated ones of the lower LCD panel sections to form at least first and second LCD panel units;

forming a first set of cutting lines substantially in the first direction on each of the first and second substrates, the first set of cutting lines spanning the entire width of the first and second substrates and corresponding to a boundary of the first LCD panel unit, wherein the first set of cutting lines extend directly over at least one sealant pattern;

forming a second set of cutting lines substantially in the first direction on each of the first and second mother substrates, the second set of cutting lines spanning only a portion of the first and second substrates and corresponding to a boundary of the second LCD panel; and

separating the first and second LCD panel units into individual LCD panels,

wherein remnants of the first and second substrates include at least one main dummy portion and at least one secondary dummy portion divided by the first set of cutting lines therebetween, and at least one of the sealant patterns under the first set of cutting lines binds the main dummy portion and secondary dummy portion together during the separating step.

17. (Previously Presented): The method according to claim 16, wherein the first LCD panel unit is larger than the second LCD panel unit, the main dummy portion and the secondary dummy portion being formed between a plurality of second LCD panel units.